



TTM Technologies, Inc. Announces Upcoming Conference Participation

November 2, 2021

SANTA ANA, Calif., Nov. 02, 2021 (GLOBE NEWSWIRE) -- TTM Technologies, Inc. (NASDAQ:TTMI), a leading global printed circuit board (PCB) and radio frequency ("RF") components and assemblies manufacturer, today announced that members of its management team will attend the following virtual investor conferences:

- The Baird Global Industrial Conference on November 9th with a presentation at 3:45 pm Eastern Time, and
- The Bank of America Leveraged Finance Conference on November 30th with a presentation at 3:00 pm Eastern Time.

All presentations will be webcast live on the company's website, www.ttm.com, and a replay will be accessible for a limited time following the events.

About TTM

TTM Technologies, Inc. is a leading global printed circuit board manufacturer, focusing on quick-turn and technologically advanced PCBs and backplane assemblies, and a global designer and manufacturer of RF and microwave components and assemblies. TTM stands for time-to-market, representing how TTM's time-critical, one-stop manufacturing services enable customers to shorten the time required to develop new products and bring them to market. Additional information can be found at www.ttm.com.

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